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² **2** Structure and morphology of SiC nanostructures synthesized on Cu films

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ARTICLE INFO

 14
 Article history:

 15
 Received 27 December 2019

 16
 Received in revised form 15 January 2020

17 Accepted 20 January 2020

18 Available online xxxx

19 Keywords:

20 Silicon carbide nanostructures

- 21 Microwave plasma
- 22 Porous silicon
- 23 Scanning electron microscopy
- 24 Raman scattering 25

ABSTRACT

The results of experiments on the synthesis of SiC nanostructures by chemical vapor deposition in microwave plasma are presented in this article. The single crystal silicon plates with orientation [111] which previously passed chemical purification were used as substrates. Furthermore, the substrates of porous silicon were prepared in order to activate the surface during the synthesis. The synthesis temperatures were 600 °C and 700 °C. Studies by scanning electron microscopy showed that formed nanostructures have a various diameter and a rough surface. The results of studies by Raman scattering confirmed that SiC nanostructures with structure of 3C-SiC are formed. Besides, the presence of main carbon peaks on both types of substrates which correspond to the carbon nanostructures should be noted. © 2020 Elsevier Ltd. All rights reserved.

Selection and peer-review under responsibility of the scientific committee of the 14th International Conference on Advanced Nano Materials.

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1. Introduction

42 **Q6** Silicon carbide (SiC) is an important semiconductor material that can operate at high powers, high temperatures and frequen-43 44 cies. This material has excellent thermal stability and is a broadband semiconductor, which properties suggest promising 45 applications for high-power, high-temperature (up to 600 °C) and 46 high-frequency (up to 20 GHz) electronic devices [1,2]. It is well 47 known that many types of sharp-pointed nanostructured materi-48 49 als, such as carbon nanotubes, silicon and silicon carbide nanofi-50 bers, are promising materials [3–6]. For example, one-51 dimensional SiC nanostructures have high compression ratios that 52 are suitable for field emitters due to their field amplification effect 53 [7].

Several methods are used to synthesize SiC nanostructures, 54 including sol-gel [3], carbothermal reduction of SiO₂, decomposi-55 tion of silicon organic compounds, laser ablation [8], and chemical 56 vapor deposition [9]. To date, CVD has often been used to produce 57 SiC nanofibers with Si sources in the solid or gas phase [10]. Con-58 59 sidering the manifold difference of this method, the synthesis of SiC nanofibers using microwave plasma assisted chemical vapor 60 deposition (MWCVD) has not been sufficiently investigated. Based 61 on this, study of the influence of synthesis parameters of MWCVD 62 63 on the surface morphology of SiC nanostructures is relevant.

This paper presents the results of studies of silicon carbide nanostructures obtained by the method of MWCVD on the surface of copper films previously deposited on porous silicon wafers by Raman scattering (RS), scanning electron microscopy (SEM) and X-ray analysis.

2. Experimental

2.1. Preparation and investigation of substrates

The monocrystalline silicon plates (analogue of brand KDB-20, 71 manufacturer Siegert Wafer GmbH, Germany) 1×1 cm with orien-72 tation [111] was used as substrates and basis for copper films. The 73 substrates of porous silicon (PSi) were prepared in the Educational 74 Laboratory of Semiconductor Instrumentation, Faculty of Physics 75 and Technology, Kazakh National University in order to activate 76 the surface during synthesis. Crystalline silicon was pretreated in 77 acetone and placed in a solution of H_2SO_4 : H_2O_2 for 5 min, followed 78 by washing in deionized water. The plates were then immersed in 79 the etch HF:H₂O for 1 min, after which they were thoroughly 80 washed. The PSi was formed by electrochemical anodizing in a 81 modified solution with composition of HF (45%): ethoxyethanol: 82 water in a ratio of 1:2:1. The current density and anodization time 83 were, respectively, 15 mA and 10 min. After etching, porous silicon 84

https://doi.org/10.1016/j.matpr.2020.01.385

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Please cite this article as: B. Zhumadilov, G. Suyundykova, G. Partizan et al., Structure and morphology of SiC nanostructures synthesized on Cu films, Materials Today: Proceedings, https://doi.org/10.1016/j.matpr.2020.01.385

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substrates were thoroughly washed in deionized water and dried
in air using lighting with a red lamp for 5 min. Fig. 1 shows SEM
image of PSi.

The copper films were deposited on surface of PSi plates by DC magnetron sputtering using equipment VUP-5M for 5 min. Sputtering was carried out in the flow of working gas Ar at a pressure of 10^{-2} Torr. The flow rate of Ar was 6 cm³/min and it was controlled by the gas flow controller MCV-500SCCM. The deposition was conducted at a constant voltage on the anode target (740 V) and plasma current of 35 mA.

95 2.2. Synthesis of silicon carbide nanostructures

Synthesis of nanostructures was carried out in the Department of Surface and Technology of New Materials at the Institute of Materials Science, University of Siegen (Germany), on equipment of MWCVD of the ASTEX system (frequency 2.45 GHz).

Prior to the experiments, the substrates were purified with ethanol and then washed with distilled water, drying was carried out at room temperature. The synthesis was carried out at temperature of 600, 700 °C, the plasma power of 1600, 1800 W and the chamber pressure of 40, 47 Torr. The temperature was measured using infrared pyrometer of model Chino IR-AP M0011 (Japan).

The mixture of trimethylsilane $((CH_3)_4Si)$ and hydrogen was used as working gas, the flow rates of which were 10 and 400 cm³/min, respectively. The duration of the experiments was 120 min.

110 2.3. Characterization

The samples of PSi were investigated by SEM in the National
nanotechnological laboratory of open type (Almaty, Kazakhstan)
using a microscope Quanta 3D 200i.

The obtained samples of SiC nanostructures were studied by the method of SEM, which was also carried out at the Institute of Materials Sciene of the University of Siegen. The field emission scanning electron microscope with ultra-high resolution of model Gemini Ultra 55 of the company Zeiss, with a device for X-ray microanalysis of the company «Thermo Scientific» was used to study the morphology and thickness of the samples.

121The nanostructures were investigated by Raman spectroscopy122using spectrometer NT-MDT NTegra Spectra (laser wavelength123 $\lambda = 473$ nm) at The National Nanotechnology Laboratory of open124type.

The study of the structure of the obtained samples is carried out by the method of X-ray analysis using diffractometer Rigaku Mini Flex 600 XRD (X-ray analysis laboratory of Al-Farabi KazNU, Almaty, Kazakhstan). Radiographs of samples were obtained using128copper radiation ($\lambda = 1.5406$ Å) in digital form. Processing of X-ray129spectra to determine angular position and intensity of the reflec-130tion was performed in program OriginPro 8.1. PDXL2 software131package with the base of diffractometric data PDF-2 was used for132the phase analysis.133

3. Results and discussion

Fig. 2 presents the results of SEM, XRD and Raman investiga-135 tions of nanostructures synthesized at 600 °C. It can be seen from 136 SEM results that nanostructures grow preferentially oriented to 137 the substrate. The diameter of the nanostructure is \sim 85 nm and 138 length is up to several micrometers. The massive growth of nanos-139 tructures over the entire surface of the substrate is observed. 140 Fig. 2a shows that the height of the synthesized nanostructures 141 is 1.6 µm. Fig. 2c presents X-ray spectra of the obtained nanostruc-142 tures. X-ray qualitative analysis of the phase composition of the 143 sample indicates presence of Si, SiC and Cu. The diffraction pattern 144 of the sample demonstrates the reflection from the planes (111) 145 and (200) $(2\theta \approx 43.1^{\circ} \text{ and } 50,4^{\circ}, \text{ Fm-3 m } \{225\}, \text{ PDF } \# 04-0836)$ 146 which are characteristic of copper. Also, the characteristic reflec-147 tion from the substrate of monocrystalline silicon Si (111) appears 148 at angle of 28.4°. The calculation of the diffractogram shows that 149 the reflection at angles of $2\theta \approx 35.7^{\circ}$ and 59.8° corresponds to 150 β-SiC [F-43 m {216}, PDF # 29-1129] from (111) and (220) planes. 151 Fig. 2d shows the Raman spectra of the samples. There are peaks of 152 silicon carbide in the region of 777.8 and 965.7 cm⁻¹, which can 153 indicate the formation of silicon carbide film with a 3C-SiC struc-154 ture [11]. In addition, one can see the main carbon peaks in the 155 range of 1344.4 and 1573.1 cm⁻¹, which correspond to carbon 156 nanostructures. Moreover, peaks of the second order are observed 157 in the region of 2683.8 and 2915.7 cm⁻¹, which correspond to 2D 158 and D + G groups [12,13]. It can be seen that the intensity of D peak 159 is higher than that of G peak, which is inherent in defective sam-160 ples. Based on this, it can be assumed that nanostructures have 161 not high quality. 162

Fig. 3 presents the results of studies by SEM, XRD and Raman 163 scattering of nanostructures synthesized at 700 °C. SEM results 164 show oriented growth of nanostructures. It was also found that 165 nanostructures grown at 700 °C have a small diameter and a large 166 length. In Fig. 3d, in the region of 777.8 and 972.5 cm⁻¹, character-167 istic peaks of SiC, corresponding to the LO and TO modes are 168 observed. Peaks observed within 1341.2 and 1570 cm⁻¹ are inher-169 ent in carbon nanotubes. It can be confirmed by the presence of 170 second-order peaks 2D and D+G at 2675.3 and 2907.4 cm^{-1} , 171 respectively. One can note a peak in the range of 1428.8 cm⁻¹, 172



Fig. 1. SEM images of porous silicon surface.

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Fig. 2. SEM images and XRD, Raman spectra of nanostructures synthesized at 600 °C.



Fig. 3. SEM images and XRD, Raman spectra of nanostructures synthesized at 700 °C.

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which belongs to CH₃ groups [13]. XRD results of samples grown at
700 °C are similar to samples synthesized at 600 °C, but show
higher intensity.

176 4. Conclusions

177 In the course of the research, experiments on the synthesis of 178 SiC nanostructures by the method of microwave plasma assisted 179 chemical vapor deposition were carried out. Studies by the method 180 of scanning electron microscopy have shown that the formed 181 nanostructures have a diameter from ten to several hundred nm 182 and a rough surface. Analysis of the samples shows the massive 183 growth of nanostructures on the surface of porous silicon.

184 XRD results show that the obtained nanostructures are 3C-SiC 185 polytypic silicon carbide nanostructures. It is also confirmed by 186 results of studies by Raman scattering. Besides, the presence of 187 main carbon peaks in the range of \sim 1300 and 1500 cm⁻¹, which 188 corresponds to the carbon nanostructures should be noted.

It is necessary to conduct additional studies using transmission
electron microscopy and diffraction of electrons for a more
detailed analysis of the structure of the obtained nanostructures.
Furthermore, the possibility of using polycrystalline silicon as a
substrate for the synthesis of silicon carbide nanostructures will
be studied.

195 CRediT authorship contribution statement

Bauyrzhan Zhumadilov: Software, Validation. Gulnur Suyundykova: Investigation, Software, Visualization. Gulmira Partizan:
Data curation, Writing - original draft, Validation. Aidar Kenzhegulov: Conceptualization, Methodology. Botagoz Medyanova: Formal analysis, Software. Bakhodir Aliyev: Supervision, Formal
analysis.

202 Acknowledgements

The authors are grateful to the candidate of physics and mathematics Dikhanbaev K.K. for assistance in the preparation of porous silicon samples, Professor Xin Jang – Director of the Institute of Materials Science, University of Siegen (Germany) for the opportunity to use the equipment.

The work was carried out with partial financial support of the grant of the Science Committee of the Ministry of Education and Science of the Republic of Kazakhstan No. AP05132865.

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